IXYS
INTEGRATED CIRCUITS DIVISION

PLA192
Single Pole, Normally Open OptoMOS® Relay

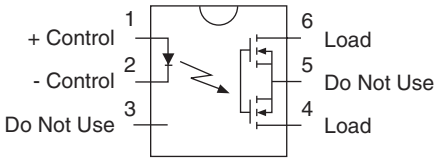
Parameters	Ratings	Units
Blocking Voltage	600	V_P
Load Current	150	mA_{rms} / mA_{DC}
On-Resistance (max)	22	Ω
LED Current to Operate	5	mA

Features
- PLA192E is 100% Tested for Partial Discharge: DIN EN 60747-5-5
- 5000V_{rms} Input/Output Isolation
- Low Drive Power Requirements
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 6-Pin Package
- Flammability Rating UL 94 V-0

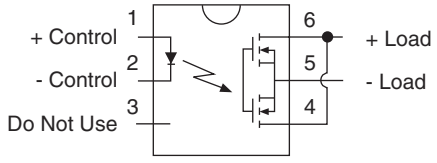
Applications
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment: Patient/Equipment Isolation
- Aerospace
- Industrial Controls

Pin Configuration

AC/DC Configuration



DC Only Configuration



Description
IXYS Integrated Circuits' PLA192 is a single-pole, normally open (1-Form-A) solid state relay that provides 5000V_{rms} of input to output isolation.

In addition to all the features and benefits of the PLA192, the PLA192E meets the partial discharge demands of DIN EN 60747-5-5 (previously VDE 0884).

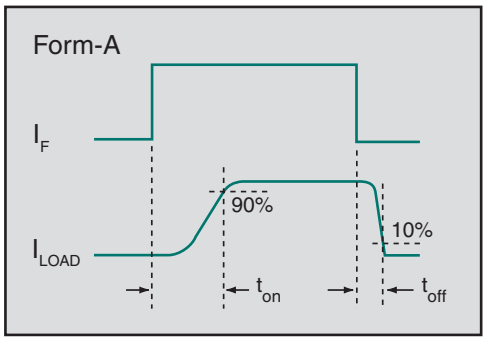
All versions of the PLA192 can be used to replace mechanical relays, while offering the superior reliability associated with semiconductor devices. Optically coupled outputs that use the patented OptoMOS architecture are controlled by a highly efficient infrared LED. Because they have no moving parts, they offer bounce-free switching in more compact surface mount or thru-hole packages.

Approvals
- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- DIN EN 60747-5-5 Certified ("E" Suffix Only) VDE Certificate 40036603
- EN/IEC 60950-1 Certified Component: Certificate available on our website

Ordering Information

Part #	Description
PLA192E	6-Pin DIP (50/Tube)
PLA192ES	6-Pin Surface Mount (50/Tube)
PLA192ESTR	6-Pin Surface Mount (1000/Reel)
PLA192	6-Pin DIP (50/Tube)
PLA192S	6-Pin Surface Mount (50/Tube)
PLA192STR	6-Pin Surface Mount (1000/Reel)

Switching Characteristics of Normally Open Devices



Absolute Maximum Ratings @ 25ºC (Unless Otherwise Noted)

Parameter	Rating	Units
Blocking Voltage	600	V_P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation [1]	150	mW
Total Package Dissipation [2]	800	mW
Isolation Voltage, Input to Output (60 Seconds)	5000	V_{rms}
ESD Rating, Human Body Model	4	kV
Operational Temperature	-40 to +85	ºC
Storage Temperature	-40 to +125	ºC

[1] Derate linearly 1.33 mW / ºC
[2] Derate linearly 6.67 mW / ºC

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

Electrical Characteristics @ 25ºC (Unless Otherwise Noted)

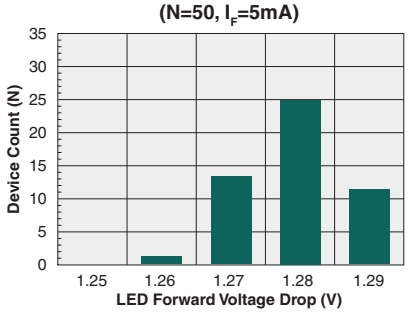
Parameters	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current						
Continuous, AC/DC Configuration	-	I_L	-	-	150	mA_{rms} / mA_{DC}
Continuous, DC-Only Configuration	-		-	-	220	mA_{DC}
Peak	t=10ms	I_{LPK}	-	-	±400	mA_P
On-Resistance						
AC/DC Configuration	I_L=150mA	R_{ON}	-	13.3	22	Ω
DC-Only Configuration	I_L=220mA		-	4.15	8	
Off-State Leakage Current	V_L=600V_P	I_{LEAK}	-	-	1	µA
Switching Speeds						
Turn-On	I_F=5mA, V_L=10V	t_{on}	-	-	5	ms
Turn-Off		t_{off}	-	-	5	
Output Capacitance	I_F=0mA, V_L=50V, f=1MHz	C_{OUT}	-	10	-	pF
Input Characteristics						
Input Control Current to Activate	I_L=100mA	I_F	-	0.22	5	mA
Input Control Current to Deactivate	-	I_F	0.1	0.21	-	mA
Input Voltage Drop	I_F=5mA	V_F	0.9	1.2	1.5	V
Reverse Input Current	V_R=5V	I_R	-	-	10	µA
Common Characteristics						
Input to Output Capacitance	V_{IO}=0V, f=1MHz	C_{IO}	-	3	-	pF

PLA192E Safety and Insulation Ratings

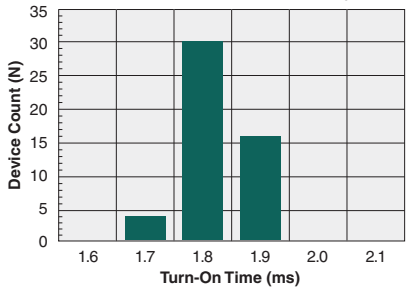
Parameters	Conditions	Symbol	Min	Max	Units
Pollution Degree 2 according to DIN VDE 0109	-	-	-	-	-
Highest Allowable Over-Voltage	Transient Voltage	V_{IOTM}	7071	-	V_P
Maximum Working Insulation Voltage	Recurring Voltage	V_{IORM}	1000	-	V_P
Partial Discharge Test Voltage	DIN EN 60747-5-5 Method B	V_{PR}	-	1875	V_P
Isolation Test Voltage	-	V_{ISO}	-	5000	V_{rms}
Creepage Distance	-	-	7.6	-	mm
Clearance Distance	-	-	7.6	-	mm

PERFORMANCE DATA*

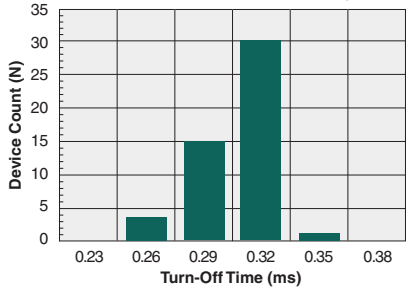
Typical LED Forward Voltage Drop (N=50, I_F=5mA)



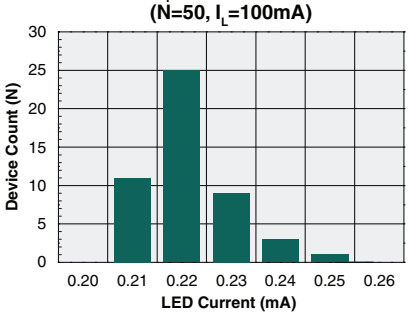
Typical Turn-On Time (N=50, I_F=5mA, I_L=100mA$_{DC}$)



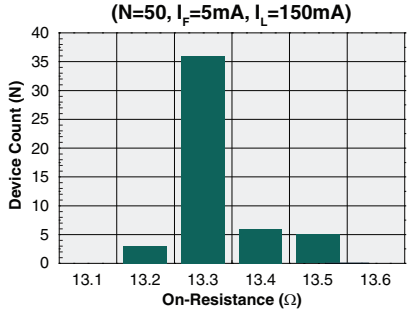
Typical Turn-Off Time (N=50, I_F=5mA, I_L=100mA$_{DC}$)



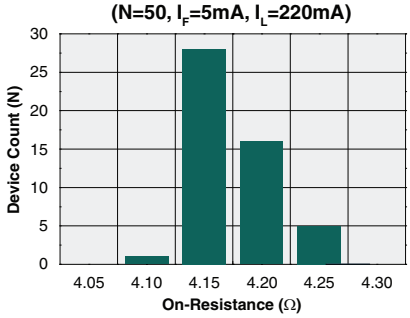
Typical I_F for Switch Operation (N=50, I_L=100mA)



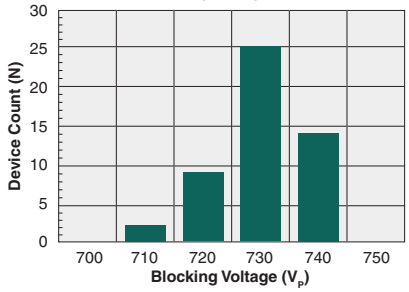
Typical On-Resistance Distribution (N=50, I_F=5mA, I_L=150mA)



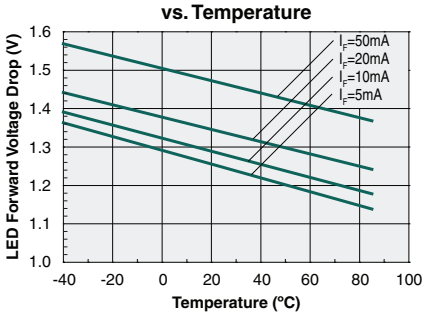
DC-Only On-Resistance Distribution (N=50, I_F=5mA, I_L=220mA)



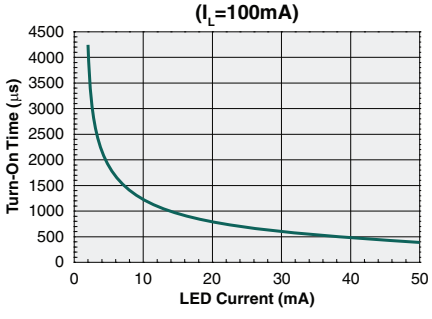
Typical Blocking Voltage Distribution (N=50)



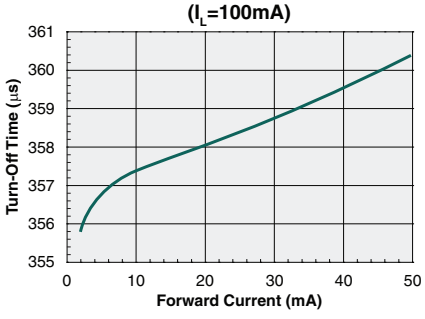
Typical LED Forward Voltage Drop vs. Temperature



Typical Turn-On Time vs. LED Forward Current (I_L=100mA)



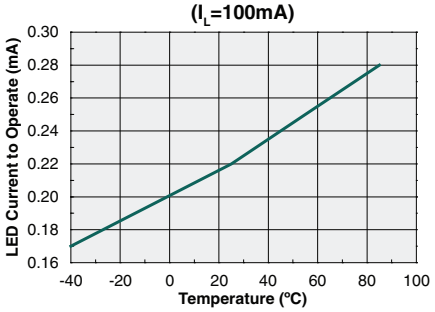
Typical Turn-Off Time vs. LED Forward Current (I_L=100mA)



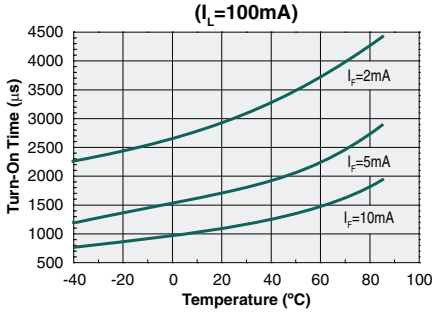
*Unless otherwise noted, data presented in these graphs is typical of device operation at 25ºC.
For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*

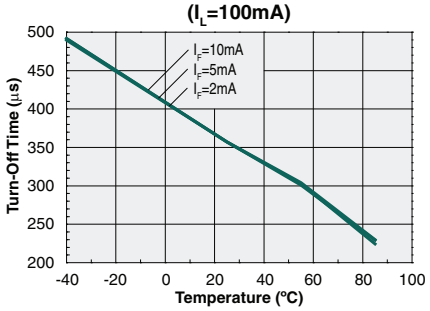
Typical I_F for Switch Operation vs. Temperature (I_L=100mA)



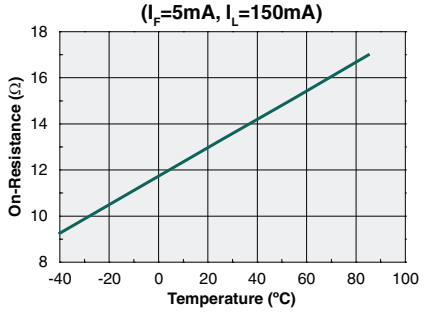
Typical Turn-On Time vs. Temperature (I_L=100mA)



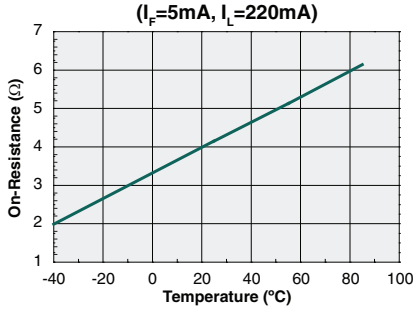
Typical Turn-Off Time vs. Temperature (I_L=100mA)



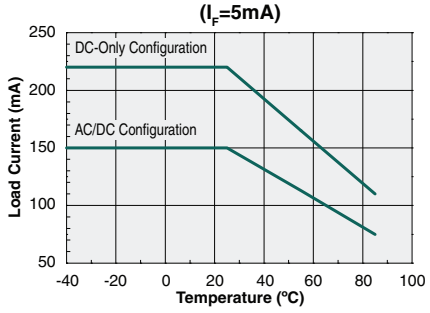
Typical AC/DC On-Resistance vs. Temperature (I_F=5mA, I_L=150mA)



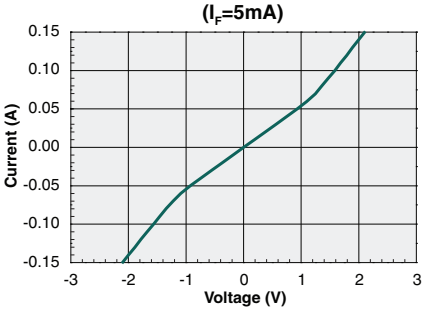
Typical DC-Only On-Resistance vs. Temperature (I_F=5mA, I_L=220mA)



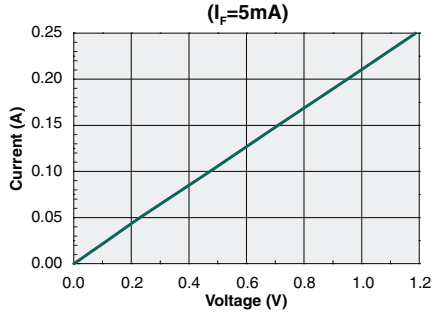
Maximum Load Current vs. Temperature (I_F=5mA)



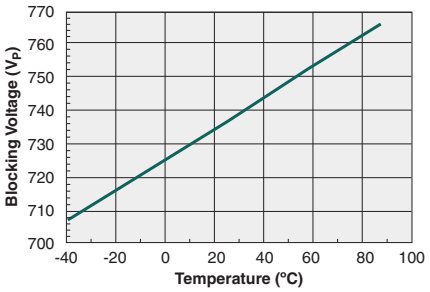
Typical Load Current vs. Load Voltage AC/DC Configuration (I_F=5mA)



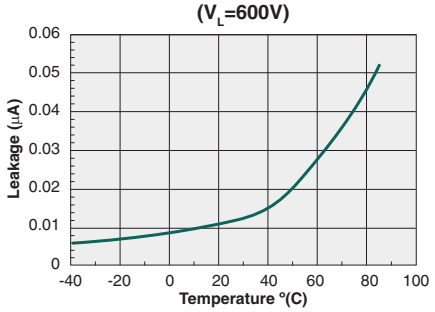
Typical Load Current vs. Load Voltage DC-Only Configuration (I_F=5mA)



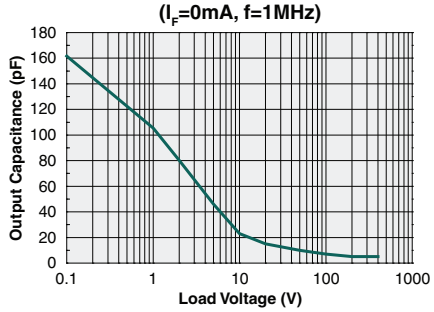
Typical Blocking Voltage vs. Temperature



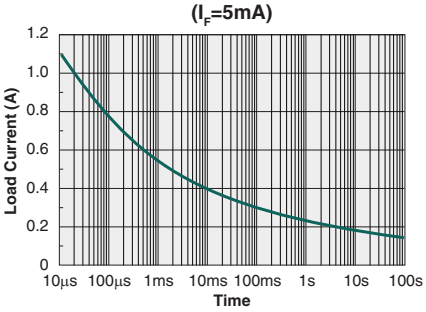
Typical Leakage vs. Temperature Measured across Pins 4&6 (V_L=600V)



Output Capacitance vs. Load Voltage (I_F=0mA, f=1MHz)



Energy Rating Curve (I_F=5mA)



*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C.
For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Classification
PLA192, PLA192S, PLA192E, PLA192ES	MSL 1

ESD Sensitivity

This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Soldering Profile

Provided in the table below is the Classification Temperature (T_C) of this product and the maximum dwell time the body temperature of this device may be (T_C - 5)°C or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of **J-STD-020** must be observed.

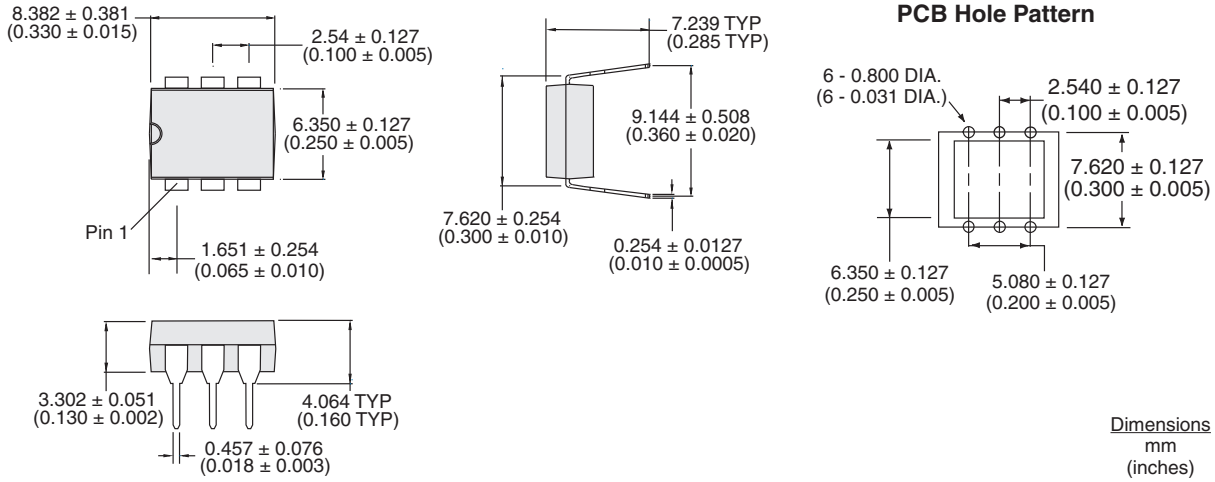
Device	Classification Temperature (T_c)	Dwell Time (t_p)	Max Reflow Cycles
PLA192, PLA192E	250°C	30 seconds	1
PLA192S, PLA192ES	250°C	30 seconds	3

Board Wash

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.

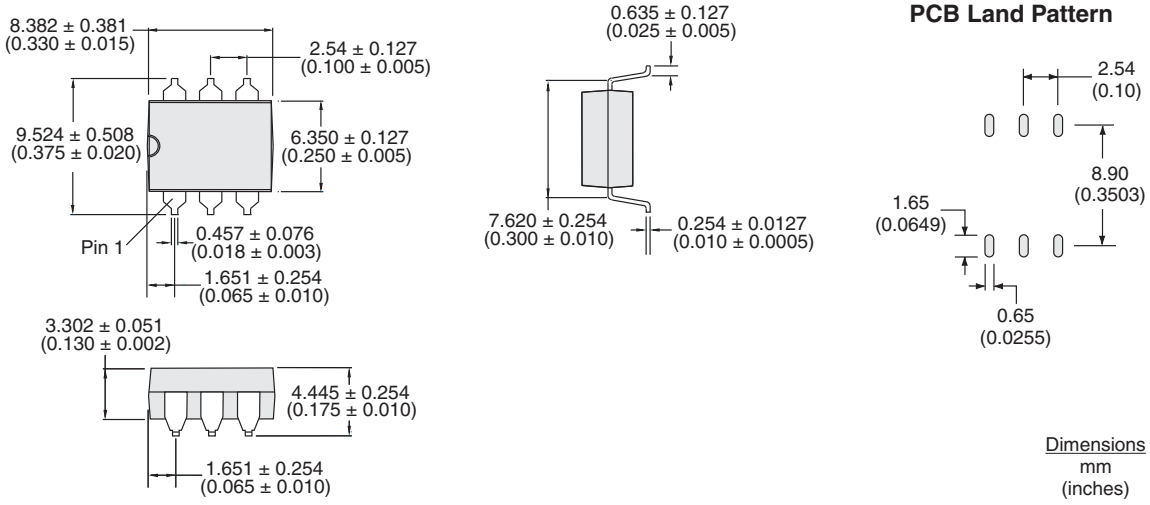
MECHANICAL DIMENSIONS

PLA192 & PLA192E



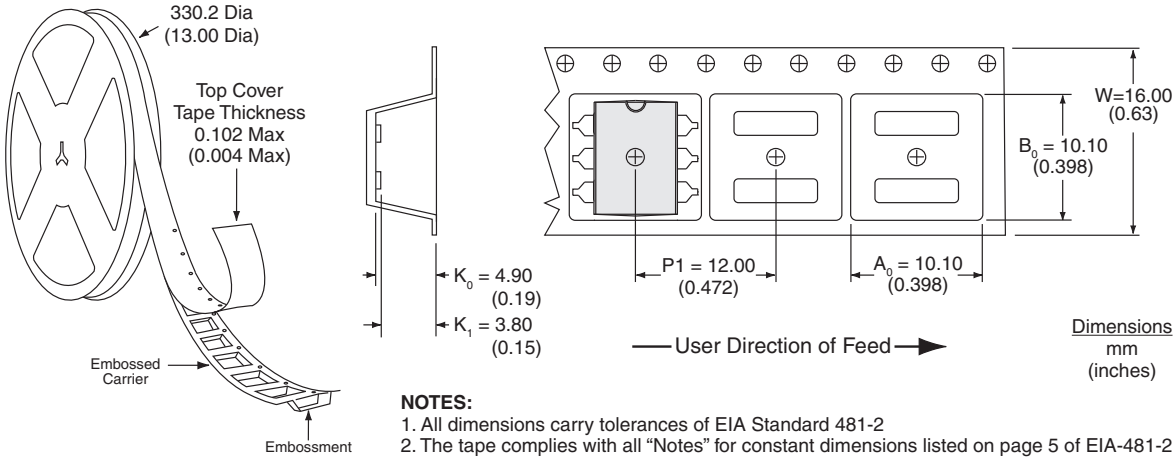
Dimensions
mm
(inches)

PLA192S & PLA192ES



Dimensions
mm
(inches)

PLA192STR & PLA192ESTR Tape & Reel



NOTES:
1. All dimensions carry tolerances of EIA Standard 481-2
2. The tape complies with all "Notes" for constant dimensions listed on page 5 of EIA-481-2

For additional information please visit our website at: www.ixysic.com

Specification: DS-PLA192-R08

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Solid State Relays - PCB Mount ***category:***

Click to view products by IXYS ***manufacturer:***

Other Similar products are found below :

M86F-2W M90F-2W G2-1A07-ST G2-1A07-TT G2-1B02-TT G2-DA06-ST G3CN-202PL-3-US DC12 G3CN-203P DC3-28 G3RDX02SNUSDC12 PLA134S DMP6202A DS11-1005 AQ3A2-ZT432VDC AQV212J AQV214SD02 AQV252GAJ AQW414EA AQY221N2SJ AQY221R2SJ EFR1200480A150 LCA220 LCB110S 1618400-5 SR75-1ST AQV112KLJ AQV212AJ AQV238AD01 AQV252GAXJ AQW414TS AQY210SXT AQY214SXT AQY221N2V1YJ AQY221R2VJ G2-1A02-ST G2-1A02-TT G2-1A03-ST G2-1A03-TT G2-1A06-TT G2-1A23-TT G2-1B01-ST G2-1B01-TT G2-1B02-ST G2-DA03-ST G2-DA03-TT G2-DA06-TT G3M-203PL-UTU-1 DC24 CPC2330N 3-1617776-2 CTA2425 TS190